

PIN 1 REFERENCE



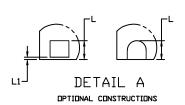
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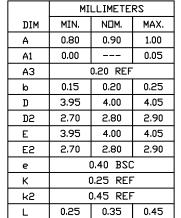
В

DATE 20 APR 2021

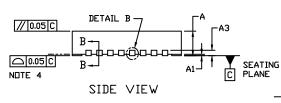
NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS
- DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.



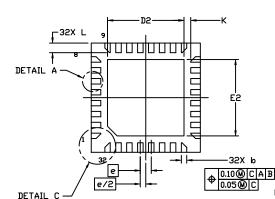


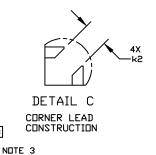
0.15

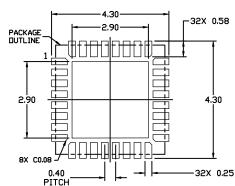


TOP VIEW









L1

RECOMMENDED
MOUNTING FOOTPRINT
For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

GENERIC MARKING DIAGRAM*

BOTTOM VIEW

XXXXXX XXXXXX **AWLYWW** XXXX = Specific Device Code

= Assembly Location

WL = Wafer Lot = Year

\\\\\ = Work Week *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	QFN32 4x4, 0.4P		PAGE 1 OF 1

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